MULTI-INNO TECHNOLOGY CO., LTD.

www.multi-inno.com

LCD MODULE SPECIFICATION

Model: MI0500HT-3

For Customer's Acceptance:

Revision	1.0
Engineering	
Date	2013-06-29
Our Reference	





REVISION RECORD

REV NO.	REV DATE	CONTENTS	REMARKS
1.0	2013-06-29	First Release	



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■ GENERAL INFORMATION

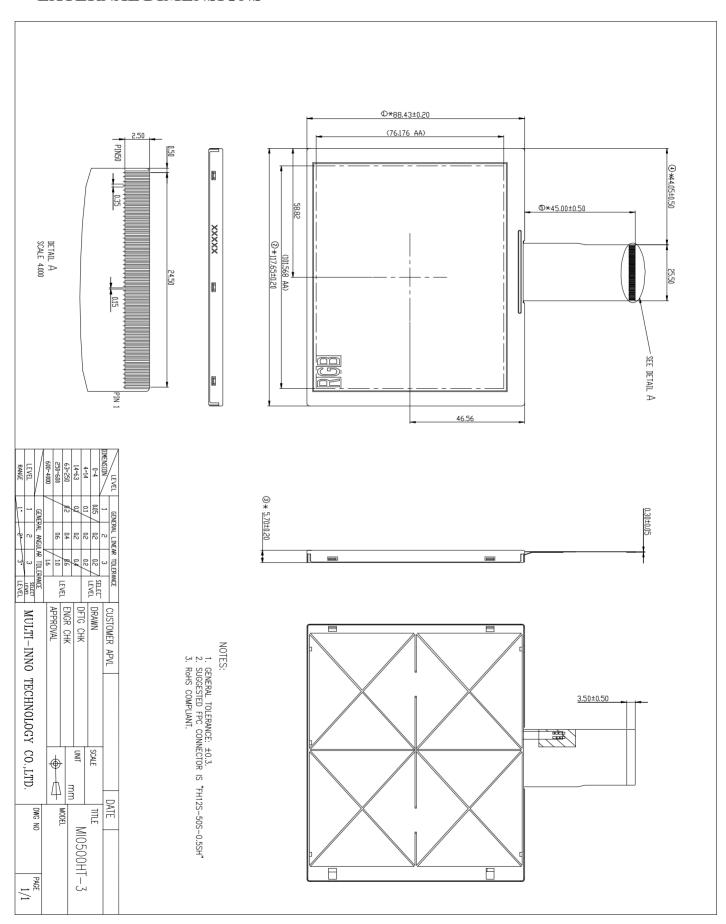
Item	Contents	Unit
LCD type	TFT/Transmissive/Normally white	/
Size	5.0	Inch
Viewing direction	12:00	O' Clock
Gray scale inversion direction	6:00	O' Clock
$LCM(W \times H \times D)$	117.65×88.43×5.70	mm ³
Active area (W×H)	101.57×76.18	mm ²
Dot pitch (W×H)	0.053×0.159	mm ²
Number of dots	640 (RGB) × 480	/
Backlight type	15 LEDs	/
Interface type	24bit RGB	/
Color depth	16.7M	/
Pixel configuration	R.G.B stripe	/
Surface treatment	Anti-glare	/
Backlight power consumption	0.96	W
Panel power consumption	TBD	W
Input voltage	3.3	V
With/Without TSP	Without TSP	/
Weight	TBD	g

Note 1: Viewing direction for best image quality is different from TFT definition, there is a 180 degree shift.

Note 2 : RoHS compliant; Note 3: LCM weight tolerance: ± 5%.



■ EXTERNAL DIMENSIONS





■ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min	Max	Unit
	DVDD	-0.3	5.0	V
	AVDD	6.5	13.5	V
Power voltage	VGH	-0.3	42	V
	VGL	-20	0.3	V
	VGH-VGL	-	40	V
LED reverse voltage(each LED)	VR	-	TBD	V
LED forward current(each LED)	IF	-	TBD	mA
Operating temperature	Тор	-20	70	°C
Storage temperature	Tst	-30	80	°C
Humidity	RH	-	90%(Max60°C)	RH

Note 1:VR conditions:Zener Diode 120mA

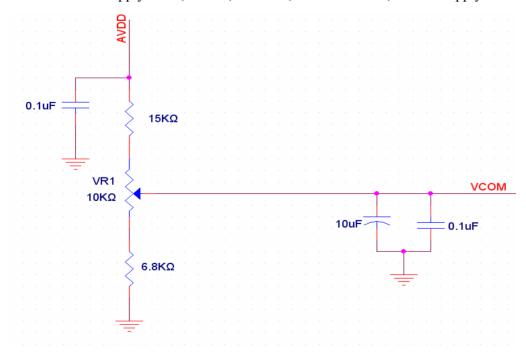
■ELECTRICAL CHARACTERISTICS

DC CHARACTERISTICS

Parameter	Symbol	Min	Тур	Max	Unit
	DVDD	3.0	3.3	3.6	V
Power voltage	AVDD	10.2	10.4	10.6	V
1 ower voltage	VGH	16.7	17.0	17.3	V
	VGL	-7.3	-7.0	-6.7	V
Input signal voltage	VCOM	3.2	3.5	3.8	V
Input voltage 'H' level	V _{IH}	0.7DVDD	-	DVDD	V
Input voltage 'L' level	$V_{\rm IL}$	0	-	0.3DVDD	V

Note 1:Typical Vcom is only a reference value, it must be optimized according to each LCM, please use VR and base on below application circuit.

Note 2:Be sure to apply GND,DVDD, and VGL, to the LCD first, and then apply VGH.





CURRENT CONSUMPTION

Item	Symbol		Values	Unit	Remark	
item	Symbol	Min.	Тур.	Max.	Oilit	Nemark
	I _{GH}	-	TBD	-	uA	V _{GH} =+17V
Current for Driver	I _{GL}	-	TBD	-	uA	V _{GL} = -7V
	I _{CC}	-	TBD	-	mA	DV _{DD} =3.3V
	I _{DD}	-	TBD	1	mA	AV _{DD} =10.4V

■ BACKLIGHT CHARACTERISTICS

Item	Symbol	Min.	Тур.	Max.	Unit	Condition
Voltage for LED backlight	VL	14.6	15.5	16.4	V	Note 1
Current for LED backlight	IL	-	60	-	mA	
LED life time	-	15,000	-	-	Hrs	Note 2

Note 1: The Voltage for LED Backlight is defined at Ta=25 $^{\circ}$ C and I_L =60mA.

Note 2: The "LED life time" is defined as the module brightness decrease to 50% original brightness that the ambient temperature is 25°C and I_L =60mA. The LED lifetime could be decreased if operating I_L is lager than 60mA.



■ELECTRO-OPTICAL CHARACTERISTICS

Item		Symbol	Condition	Min	Тур	Max	Unit	Remark	Note
Response	time	Tr+Tf		-	25	50	ms	FIG 1.	4
Contrast r	atio	Cr	θ=0°	400	500	-		FIG 2.	1
Luminar uniform		δ WHITE	Ø=0° Ta=25°C	70	75	-	%	FIG 2.	3
Surface Lum	inance	Lv		200	250	-	cd/m ²	FIG 2.	2
			Ø = 90°	40	50	-	deg	FIG 3.	
Viouving and	V:i1	0	Ø = 270°	60	70	-	deg	FIG 3.	6
Viewing angle range		θ	Ø = 0°	60	70	-	deg	FIG 3.	O
			Ø = 180°	60	70	-	deg	FIG 3.	
	Red	X		-	-	-			
	Reu	у		-	-	-			
	Green	X	θ=0°	-	-	-			
CIE (x, y)	Officer	у	Ø=0°	-	-	-		FIG 2.	5
chromaticity	Blue	X	Ta=25℃	-	-	-		110 2.	
	Diuc	у	1 a-25 C	-	-	-			
	White	X		0.26	0.31	0.36			
	White	у		0.28	0.33	0.38			

Note 1. Contrast Ratio(CR) is defined mathematically as For more information see FIG 2.

Contrast Ratio = Average Surface Luminance with all white pixels (P1, P2, P3, P4, P5)

Average Surface Luminance with all black pixels (P1, P2, P3, P4, P5)

Note 2. Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information see FIG 2.

Lv = Average Surface Luminance with all white pixels (P1, P2, P3, P4, P5)

Note 3. The uniformity in surface luminance , δ WHITE is determined by measuring luminance at each test position 1 through 5, and then dividing the maximum luminance of 5 points luminance by minimum luminance of 5 points luminance. For more information see FIG 2.

δ WHITE = Minimum Surface Luminance with all white pixels (P1, P2, P 3, P4, P5)

Maximum Surface Luminance with all white pixels (P1, P2, P 3, P4, P5)

- Note 4. Response time is the time required for the display to transition from White to black(Rise Time, Tr) and from black to white(Decay Time, Tf). For additional information see FIG 1. The test equipment is Autronic-Melchers's ConoScope. Series.
- Note 5. CIE (x, y) chromaticity, The x, y value is determined by measuring luminance at each test position 1 through 5, and then make average value.
- Note 6. Viewing angle is the angle at which the contrast ratio is greater than 2. For TFT module the conrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.
- Note 7. For viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope. Series Instruments For contrast ratio, Surface Luminance, Luminance uniformity, CIE The test data is base on TOPCON's BM-5 photo detector.



FIG. 1 The definition of Response Time

The response time is defined as the following figure and shall be measured by switching the input signal for "black" and "white".

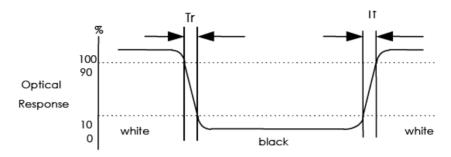
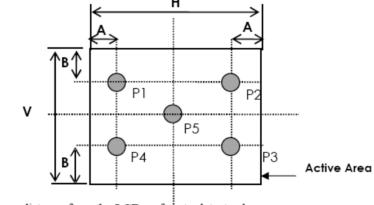


FIG. 2 Measuring method for Contrast ratio, surface luminance, Luminance uniformity, CIE (x, y) chromaticity

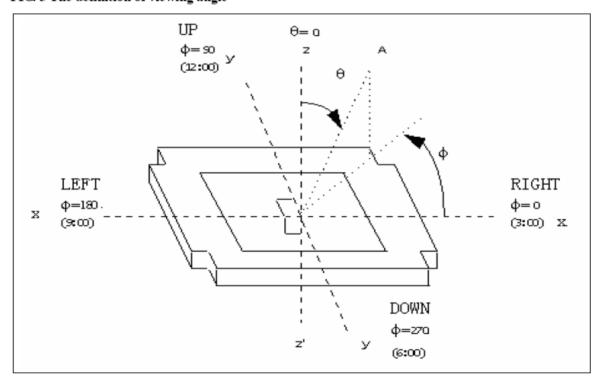


A: 5 mm B: 5 mm

H,V: Active Area

Light spot size ∅=7mm, 500mm distance from the LCD surface to detector lens measurement instrument is TOPCON's luminance meter BM-5

FIG. 3 The definition of viewing angle





■ INTERFACE DESCRIPTION

TTL connector is used for the module electronics interface. The recommended model is FH12S-50S-0.5SH manufactured by HiRose.

Pin No.	Symbol	I/O	Function	Remark
1	V_{LED} +	Р	Power for LED Circuit	
2	V_{LED} +	Р	Power for LED Circuit	
3	V_{LED}	Р	Power for LED Circuit	
4	V_{LED}	Р	Power for LED Circuit	
5	GND	Р	Power ground	
6	V_{COM}	I	V _{COM} input	
7	DV_DD	Р	Power for Digital Circuit	
8	MODE	I	DE or HV mode control	Note1
9	DE	I	Data Enable	
10	VS	I	Vsync signal input	
11	HS	ı	Hsync signal input	
12	B7	I	Blue data input (MSB)	
13	В6	I	Blue data input	
14	B5	I	Blue data input	
15	B4	I	Blue data input	
16	В3	I	Blue data input	
17	B2	l	Blue data input	
18	B1	l	Blue data input	
19	В0	l	Blue data input(LSB)	
20	G7	I	Green data input(MSB)	
21	G6	l	Green data input	
22	G5	l	Green data input	
23	G4	I	Green data input	
24	G3	I	Green data input	
25	G2	I	Green data input	
26	G1	I	Green data input	
27	G0	I	Green data input(LSB)	
28	R7	I	Red data input(MSB)	
29	R6	ı	Red data input	
30	R5	ı	Red data input	
31	R4	I	Red data input	
32	R3	ı	Red data input	
33	R2	ı	Red data input	
34	R1		Red data input	



35	R0	-	Red data input(LSB)	
36	GND	Р	Power ground	
37	DCLK	I	Sample clock	
38	GND	Р	Power ground	
39	L/R	I	Select left to right scanning direction	Note2
40	U/D	I	Select up or down scanning direction	Note2
41	VGH	I	Positive power for scan driver	
42	VGL	I	Negative power for scan driver	
43	AV_DD	Р	Power for Analog Circuit	
44	RESET	I	Reset	
45	NC	-	No Connector	
46	V_{COM}	I	V _{COM} input	
47	NC	-	No Connector	
48	NC	-	No Connector	
49	NC		No Connector	
50	NC	-	No Connector	

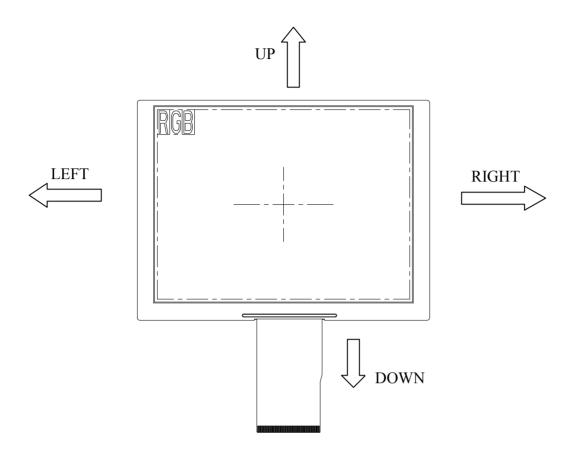
Note: I: input, O: output, P: Power

Note 1: DE Mode, Mode="H", HS floating and VS floating
HV Mode, Mode="L" and DE floating

Note2: Selection of scanning mode

Setting of scan cor	ntrol input	Scanning direction
U/D	L/R	Ğ
DV_{DD}	DV_DD	Up to down, left to right
GND	DV_DD	Down to up, left to right
DV_{DD}	GND	Up to down, right to left
GND	GND	Down to up, right to left







■ APPLICATION NOTES

1. Timing Characteristics

1.1 Timing Conditions Input/Output Timing

Item	Symbol	Symbol			Unit.	Remark	
item	Symbol	Min.	Тур.	Max.	Offit.	Remark	
PXLCLK clock time	Tclk	12.3	13.5	-	ns	1 Tclk	
PXLCLK pulse duty	Tcwh	40	50	60	%	Tclk	
DATA set-up time	Tdsu	5	-	-	ns	DATA to PXLCLK	
DATA hold time	Tdhd	5	-	-	ns	DATA to PXLCLK	
DE setup time	Tesu	5	-	-	ns	DE to PXLCLK	
VSYNC setup time	Tvst	5	-	-	ns		
VSYNC hold time	Tvhd	5	-	-	ns		
HSYNC setup time	Thst	5	-	-	ns		
HSYNC hold time	Thhd	5	-	-	ns		
HSYNC period time	Th	22.91	-	-	us		
HSYNC width	Thwh	1	-	-	Tclk		
VSYNC width	Tvwh	1	-	-	Th		

Input Timing Limitation of DE Mode

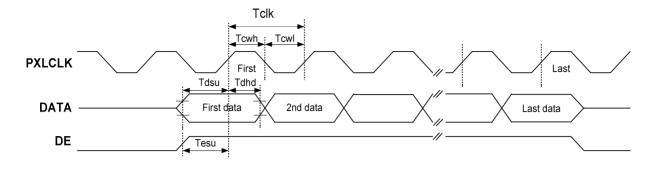
DE Mode		Values	Unit	Remark	
DE Mode	Min.	Тур.	Max.	Offic	Remark
THC	40	160	480	tclk	
THD	640	640	640	tclk	
TH	680	800	1100	tclk	1TH=1line
TVC	5	45	220	Line	
TVD	480	480	480	line	
TV	485	525	700	line	1TV=1field

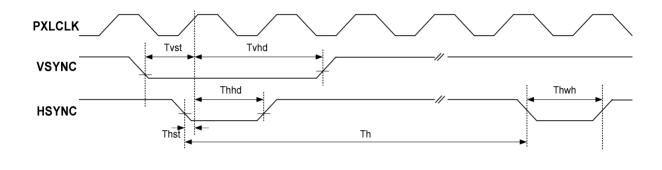


HV Mode		Values	Unit	Remark	
nv wode	Min.	Тур.	Max.	Offic	Remark
Thwh	-	4	-	tclk	
Thbp	-	42	-	tclk	
Thfp	-	114	-	tclk	
THD	-	640	-	tclk	
TH	-	800	-	tclk	
Tvwh	-	3	-	line	
Tvbp	-	31	-	line	
Tvfp	-	11	-	line	
TVD	-	480	-	line	
TV	-	525	-	line	1TV=1field



2. Timing Diagram





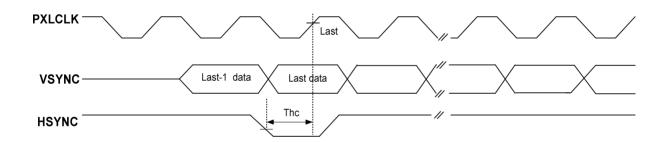


Fig.3-1 Clock and Data Input Timing Diagram



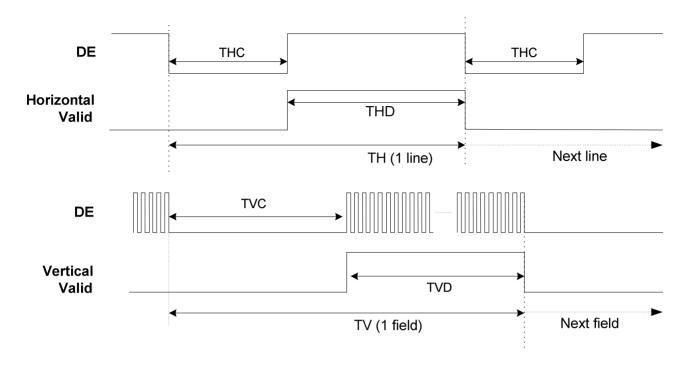


Fig.3-2 DE Mode Input Timing

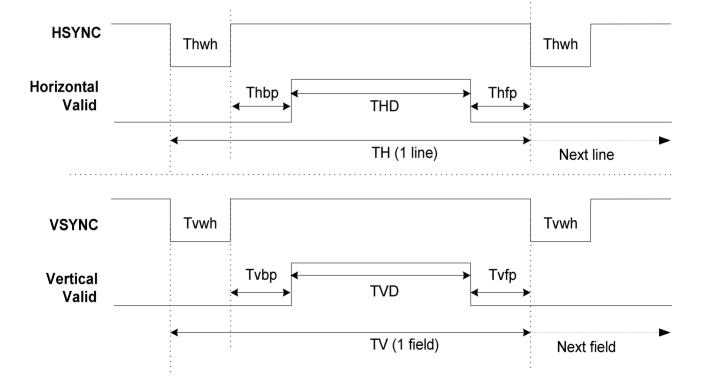


Fig.3-3 HV Mode Input Timing



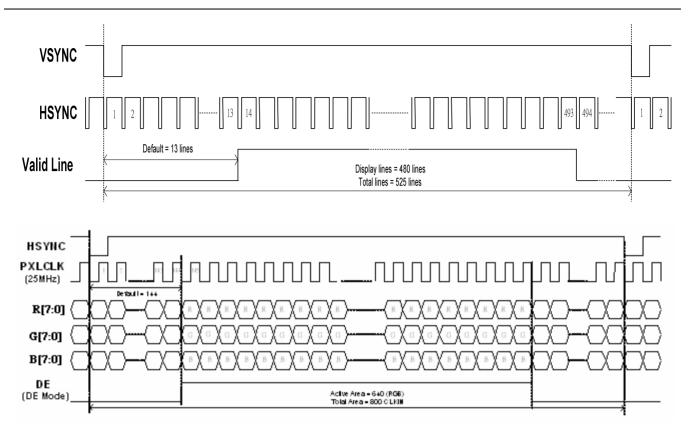
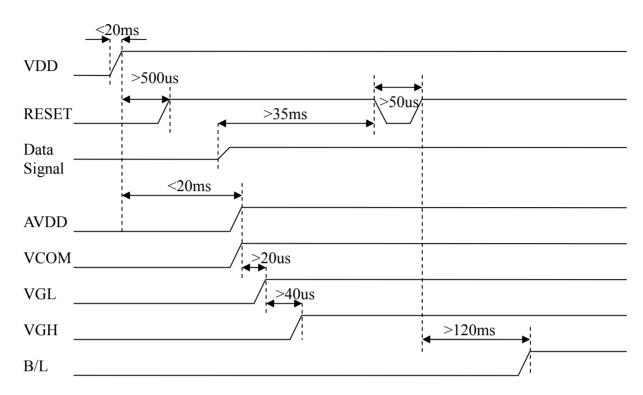


Fig. 3-4 24 bit RGB mode for 640 x (RGB) x 480

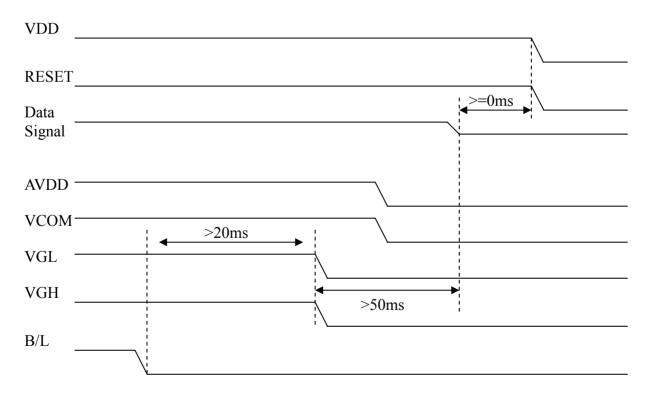


3. Power Sequence

1. Power on:



2. Power off:



Note:Data includes DE, VS ,HS,B0~B7,G0~G7,R0~R7,DCLK.





■ RELIABILITY TEST

No.	Test Item	Test Condition	Inspection after test
1	High Temperature Storage	80 ± 2 °C/240 hours	Note 1,Note 4
2	Low Temperature Storage	-30 ± 2 °C/240 hours	Note 1,Note 4
3	High Temperature Operating	70±2°C/240 hours	Note 2,Note 4
4	Low Temperature Operating	-20±2°C/240 hours	Note 1,Note 4
5	Temperature Cycle	$-30\pm2^{\circ}\text{C}\sim25\sim70\pm2^{\circ}\text{C}\times100\text{cycles}$	Note 4
6	Damp Proof Test	40°C ±5°C ×90%RH/240 hours	Note 4
7	Vibration Test	Frequency range: 10Hz~55Hz Stroke: 1.5mm, Sweep: 10Hz~55Hz~10Hz 2hours for each direction of X,Y,Z. (6 hours for total)	
8	Mechanical Shock	100G 6ms, ±X,±Y,±Z 3times for each direction	
9	Package Drop Test	Height:60 cm 1 corner, 3 edges, 6 surfaces	
10	Package Vibration Test	Random Vibration: 0.015G*G/Hz from 5-200Hz,-6dB/Octave from 200-500Hz 2 hours for each direction of X.Y.Z. (6 hours for total)	
11	ESD test	±2KV,Human Body Mode, 100pF,/1500Ω	

- Note 1: Ta is the ambient temperature of samples.
- Note 2: Ts is the temperature of panel's surface.
- Note 3: In the standard condition, there shall be no practical problem that may affect the display function. After the reliability test, the product only guarantees operation, but doesn't guarantee all the cosmetic specification.
- Note 4: Before cosmetic and function tests, the product must have enough recovery time,at least 2 hours at room temperature.

■ INSPECTION CRITERION

OUTGOING QUALITY STANDARD	PAGE 1 OF 6
TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA	MDS Product

This specification is made to be used as the standard acceptance/rejection criteria for minimum 4.3 "Color mobile phone LCM.

1 Sample plan

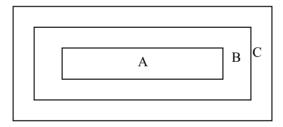
Sampling plan according to GB/T2828.1-2003/ISO 2859-1: 1999 and ANSI/ASQC Z1.4-1993, normal level 2 and based on:

Major defect: AQL 0.65 Minor defect: AQL 1.5

2. Inspection condition

Viewing distance for cosmetic inspection is about 30cm with bare eyes, and under an environment of 20~40W light intensity, all directions for inspecting the sample should be within 45° against perpendicular line.

3. Definition of inspection zone in LCD



Zone A: character/Digit area

Zone B: viewing area except Zone A (ZoneA+ZoneB=minimum Viewing area)

Zone C: Outside viewing area (invisible area after assembly in customer's product)

Fig.1 Inspection zones in an LCD.

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product.



OUTGOING QUALITY STANDARD	PAGE 2 OF 6
TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA	MDS Product

4. Inspection standards

4.1 Major Defect

Item No	Items to be inspected	Inspection Standard	Classification of defects
4.1.1	All functional defects	 No display Display abnormally Missing vertical, horizontal segment Short circuit Back-light no lighting, flickering and abnormal lighting. 	
4.1.2	Missing	Missing component	Major
4.1.3	Outline dimension	Overall outline dimension beyond the drawing is not allowed.	

4.2 Cosmetic Defect

Item No	Items to be inspected	Inspection Standard Classification of defects						
	a	For dark/white s $\Phi = \frac{(x+y)}{2}$	spot, size⊕i	s defined	$\bigcap_{X} \bigwedge^{y}$			
	Clear Spots							
		Zone		Acceptable Q	ty			
	Black and white Spot	Size(mm)	A	В	С			
4.2.1	defect	Ф ≤0.1	Igr	nore				
7.2.1	Pinhole, Foreign	Foreign	Foreign	0.10<Ф≤0.20		2		Minor
	Particle, Dirt under	0.20< Φ≤0.25		1	Ignore			
	polarizer	0.25<Ф		0				
		<u> </u>						



OUTGOING QUALITY STANDARD	PAGE 3 OF 6
TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA	MDS Product

Items to be inspected		Inspection Sta	ndard			Classification of defects
	Zone	Acc	ceptable	e Qty		
Dim Spots	Size(mm)	A	В		С	
	Ф ≤0.2	Ignore	;			
Circle	0.20< Ф ≤ 0.40	2	2			Minor
and dim	0.40<Ф≤0.60	1			Ignore	
	0.60<Ф	0				
	Size	(mm)	A	ccepta	ble Qty	
T .		W(Width)	Zone		ne	
Line defect	L(Length)					
derect			A	В	С	
Black line,	Ignore	W≤0.02	A Ign		С	
Black line, White line,	Ignore L≤5.0	W≤0.02 0.02 <w≤0.03< td=""><td></td><td>ore</td><td>С</td><td>Minor</td></w≤0.03<>		ore	С	Minor
Black line, White			Ign	ore	C	Minor
	Dim Spots Circle shaped and dim edged defects Line	inspected Zone Size(mm) Dim Spots $\Phi \leq 0.2$ Circle shaped and dim edged defects $0.40 < \Phi \leq 0.60$ $0.60 < \Phi$ Size Line L(Length)	Dim Spots Circle shaped and dim edged defects Size(mm) $\Phi \leqslant 0.2$ $0.20 < \Phi \leqslant 0.40$ $0.40 < \Phi \leqslant 0.60$ Size(mm) Size(mm) Size(mm)	Dim Spots Circle shaped and dim edged defects Size(mm) A B $\Phi \leqslant 0.2$ Ignore $0.20 < \Phi \leqslant 0.40$ 2 $0.40 < \Phi \leqslant 0.60$ 1 Size(mm) A B Size(mm) A B Oxidates Acceptable of the shaped of the sha		



OUTGOING QUALITY STANDARD	PAGE 4 OF 6
TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA	MDS Product

Item No	Items to be inspected	Inspection Standard					Classification of defects
		cover assembling the line defect of the Polarizer	r scratch can be ng or in the opera of 4.2.2. scratch can be seen me special angle,	ating onl	condit y in n	ion, judge by on-operating	
		Size	e(mm)	A	ccepta	ıble Qty	
4.2.3	Polarizer scratch	L(Length)	W(Width)		Zo	ne	Minor
		L(Lengur)	· · · · · · · · · · · · · · · · · · ·	A	В	С	1,11101
		Ignore	W≤0.03	Igr	nore		
		5.0 <l\le 10.0<="" td=""><td>0.03<w\le 0.05<="" td=""><td colspan="2">2</td><td></td><td></td></w\le></td></l\le>	0.03 <w\le 0.05<="" td=""><td colspan="2">2</td><td></td><td></td></w\le>	2			
		L≤5.0	$0.05 \le W \le 0.08$		1	Ignore	
			0.08 <w< td=""><td></td><td>0</td><td></td></w<>		0		
4.2.4	Polarize Air bubble	Air bubbles between 2. Zone Size(mm) $\Phi \leq 0.2$ $0.20 < \Phi \leq 0.30$ $0.30 < \Phi \leq 0.50$	A Ignore 2	ceptabl	le Qty	C	Minor

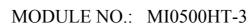


	OUTGOIN	G QUALITY ST	PAGE 5 OF 6			
TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA MDS F					Product	
Item No	Items to be inspected	Inspection Standard			Classification of defects	
	Glass	Chips on the c	Y 0 ≤S contact pad length orner of terminal shall not be	Z Disregard De allowed to extend	Minor	
4.2.5	Glass defect	(ii)Usual surface	de cracks			



OUTGOING QUALITY STANDARD	PAGE 6 OF 6
TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA	MDS Product

Item No	Items to be inspected	Inspection Standard	Classification of defects
4.2.6	Parts alignment	 Not allow IC and FPC/heat-seal lead width is more than 50% beyond lead pattern. Not allow chip or solder component is off center more than 50% of the pad outline. 	Minor
4.2.7	SMT	According to the <acceptability assemblies="" electronic="" of=""> IPC-A-610C class 2 standard. Component missing or function defect are Major defect, the others are Minor defect.</acceptability>	





■ PRECAUTIONS FOR USING LCD MODULES

Handing Precautions

- (1) The display panel is made of glass and polarizer. As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock by dropping it or impact.
- (2) If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
- (3) Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degraded insulation between terminals (some cosmetics are determined to the polarizer).
- (4) The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.). Do not put or attach anything on the display area to avoid leaving marks on. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming is contacting with room temperature air.
- (5) If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents
 - Isopropyl alcohol
 - Ethyl alcohol

Do not scrub hard to avoid damaging the display surface.

- (6) Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.
 - Water
 - Ketone
 - Aromatic solvents

Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading. Avoid contacting oil and fats.

- (7) Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- (8) Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
 - (9) Do not attempt to disassemble or process the LCD module.
 - (10) NC terminal should be open. Do not connect anything.
 - (11) If the logic circuit power is off, do not apply the input signals.
- (12) Electro-Static Discharge Control, Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
- Before remove LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential. Be sure to ground the body when handling the LCD modules.
- Tools required for assembling, such as soldering irons, must be properly grounded. make certain the AC power source for the soldering iron does not leak. When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.
- To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions. To reduce the generation of static electricity be careful that the air in the work is not too dried. A relative humidity of 50%-60% is recommended. As far as possible make the electric potential of your work clothes and that of the work bench the ground potential
- The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated



- (13) Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.
 - Do not alter, modify or change the shape of the tab on the metal frame.
- Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
 - Do not damage or modify the pattern writing on the printed circuit board.
 - Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.
- Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
 - Do not drop, bend or twist LCM.

Storage Precautions

When storing the LCD modules, the following precaution is necessary.

- (1) Store them in a sealed polyethylene bag. If properly sealed, there is no need for the dessicant.
- (2) Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C.
- (3) The polarizer surface should not come in contact with any other objects. (We advise you to store them in the container in which they were shipped).

Others

Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.

If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.

To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.

- Exposed area of the printed circuit board.
- -Terminal electrode sections.



2 Handling precaution for LCM

2.1 LCM is easy to be damaged. Please note below and be careful for handling.

2.2 Correct handling:





As above picture, please handle with anti-static gloves around LCM edges.

2.3 Incorrect handling:



Please don't touch IC directly.



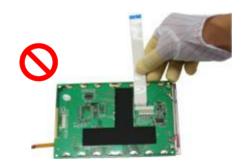
Please don't hold the surface of panel.



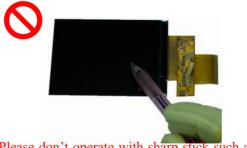
Please don't hold the surface of IC.



Please don't stack LCM.



Please don't stretch interface of output, such as FPC cable



Please don't operate with sharp stick such as pens.



3 Storage Precautions

- 3.1 When storing the LCD modules, the following precaution are necessary.
 - 3.1.1 Store them in a sealed polyethylene bag. If properly sealed, there is no need for the desiccant.
 - 3.1.2 Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C, and keep the relative humidity between 40%RH and 60%RH
 - 3.1.3 The polarizer surface should not come in contact with any other objects (We advise you to store them in the anti-static electricity container in which they were shipped).

3.2 Transportation Precautions

- 3.2.1 During shipment, please handle with care. The packaging bag can not be broken, step on trap. Packaging Carton layer height can not be over two meters.
- 3.2.2 The transportation process should pay attention to the waterproof and moisture-proof measures. Product can not be watering. Ethylene sealed bags can not be unsealed.

3.3 Others

- 3.3.1 Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.
- 3.3.2 If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.
- 3.3.3 To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.
 - 3.3.3.1 Exposed area of the printed circuit board.
 - 3.3.3.2 -Terminal electrode sections.

4.3 Precaution for soldering the LCM

	Manual soldering	Machine drag soldering	Machine press soldering
No RoHS Product	290°C ~350°C. Time : 3-5S.	330°C ~350°C. Speed : 4-8 mm/s.	300°C ~330°C. Time : 3-6S. Press: 0.8~1.2Mpa
RoHS Product	340°C ~370°C. Time : 3-5S.	350°C ~370°C. Time : 4-8 mm/s.	330°C ~360°C. Time : 3-6S. Press: 0.8~1.2Mpa

4.3.1 If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation (This does not apply in the case of a non-halogen type of flux). It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.



- 4.3.2 When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.
- 4.3.3 When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged

4.4 Precautions for Operation

- 4.4.1 Viewing angle varies with the change of liquid crystal driving voltage (VLCD). Adjust VLCD to show the best contrast.
- 4.4.2 It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life. An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided
- 4.4.3 Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operating temperature.
- 4.4.4 If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.
- 4.4.5 A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit. Usage under the maximum operating temperature, 50%RH or less is required.
- 4.4.6 Input logic voltage before apply analog high voltage such as LCD driving voltage when power on. Remove analog high voltage before logic voltage when power off the module. Input each signal after the positive/negative voltage becomes stable.
- 4.4.7 Please keep the temperature within the specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.

4.5 Safety

- 4.5.1 It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.
- 4.5.2 If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

4. 6 Limited Warranty

Unless agreed between Multi-Inno and the customer, Multi-Inno will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with Multi-Inno LCD acceptance standards (copies available upon request) for a period of one year from date of production. Cosmetic/visual defects must be returned to Multi-Inno within 90 days of shipment. Confirmation of such date shall be based on data code on product. The warranty liability of Multi-Inno limited to repair and/or replace on the terms set forth above. Multi-Inno will not be responsible for any subsequent or consequential events.



4.7 Return LCM under warranty

- 4.7.1 No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are :
 - 4.7.1.1 Broken LCD glass.
 - 4.7.1.2 PCB eyelet is damaged or modified
 - 4.7.1.3 -PCB conductors damaged.
 - 4.7.1.4 Circuit modified in any way, including addition of components.
 - 4.7.1.5 PCB tampered with by grinding, engraving or painting varnish.
 - 4.7.1.6 Soldering to or modifying the bezel in any manner.
 - 4.7.2 Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB eyelet, conductors and terminals.

■ PACKING SPECIFICATION

Please consult our technical department for detail information.

■ PRIOR CONSULT MATTER

- 1 For Multi-Inno standard products, we keep the right to change material, process ... for improving the product property without prior notice to our customer.
- 2 For OEM products, if any changes are needed which may affect the product property, we will consult with our customer in advance.
- 3 If you have special requirement about reliability condition, please let us know before you start the test on our samples.